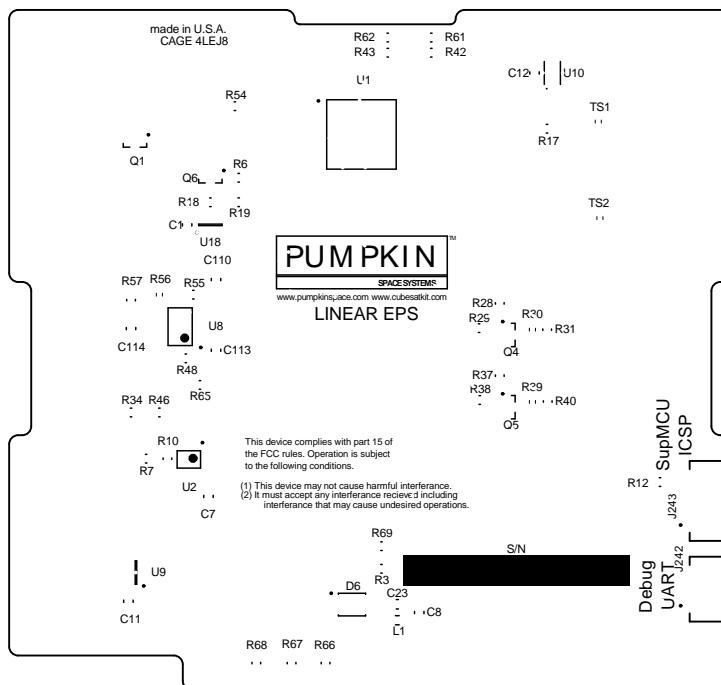
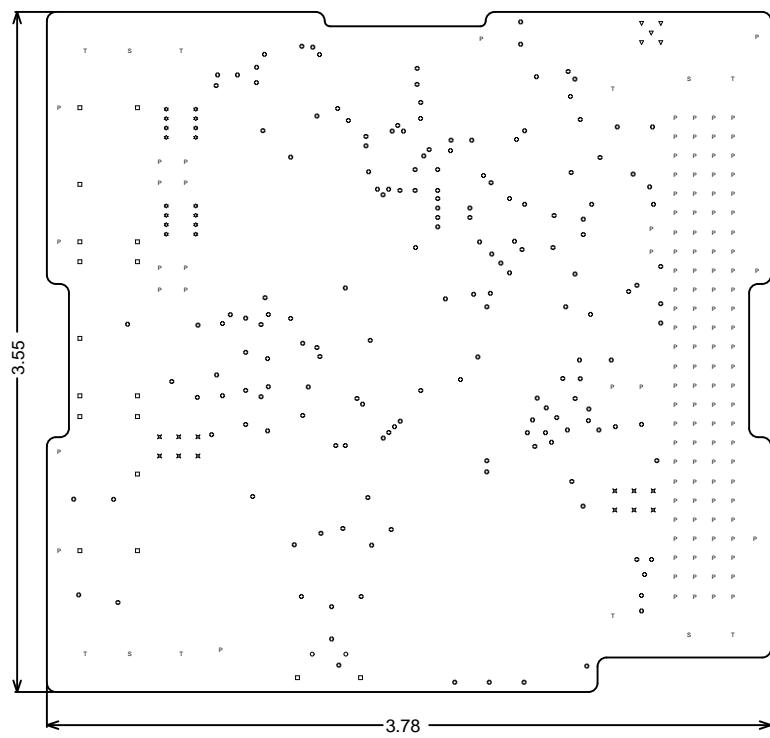


Bottom Sickscreen

02-003373-E0



705-00337E0 Mechanical Drawing
Drill Drawing

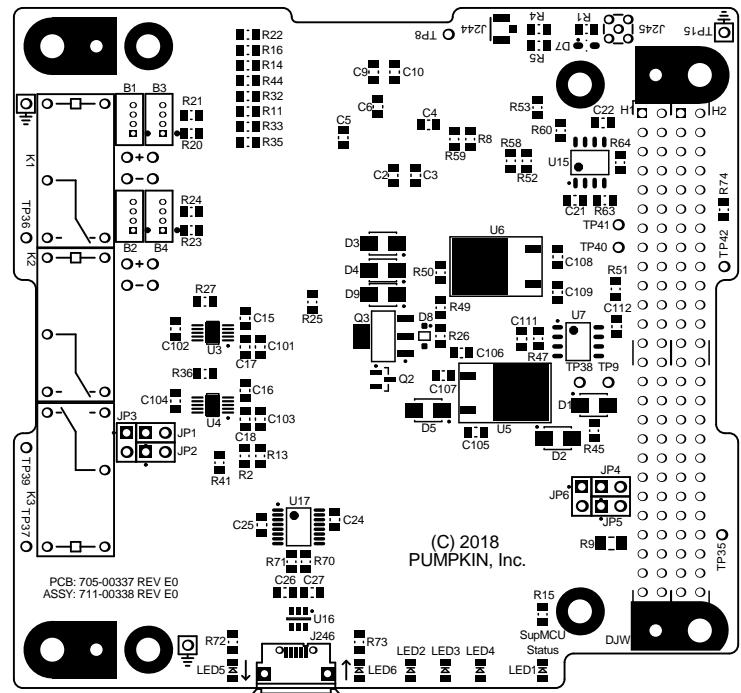


FABRICATION NOTES:

1. ALL DIMENSIONS IN INCHES
2. SCALE IS 1:1
4. SMOBC BOTH SIDES, COLOR: BLUE
5. SOLDERMASK IS LPI, SEMI-GLOSS FINISH
6. SILKSCREEN LEGEND WHITE
7. SILKSCREEN TOP AND BOTTOM
8. FINAL BOARD THICKNESS = 0.062"
9. FINAL COPPER THICKNESS = 10Z
10. 4 CIRCUIT LAYERS, STACKUP //8mil//37mil//8mil//
11. MINIMUM SPACING 0.007"
12. MINIMUM SMD PITCH IS 0.020"
13. SURFACE MOUNT COMPONENTS TOP AND BOTTOM
14. DO NOT ADD TOOLING HOLES
16. NUMBER OF SMD PADS: 464
17. NUMBER OF HOLES: 364
18. SMALLEST HOLE IS 0.5mm
19. ENTIRE BOARD TO BE IMMERSION GOLD 2 MICROINCHES
MINIMUM OVER ELECTROLESS NICKEL 150 MICROINCHES
PER IPC-4552

Symbol	Count	Hole Size	Plated	Hole Type
O	2	26.00mil (0.660mm)	PTH	Round
S	4	65.00mil (1.651mm)	PTH	Round
▽	5	33.07mil (0.840mm)	PTH	Round
T	8	125.00mil (3.175mm)	PTH	Round
✗	12	39.37mil (1.000mm)	PTH	Round
❖	16	23.62mil (0.600mm)	PTH	Round
□	17	37.00mil (0.940mm)	PTH	Round
P	125	40.16mil (1.020mm)	PTH	Round
+	175	19.69mil (0.500mm)	PTH	Round
364 Total				

705-00337E0 Top Silkscreen
Top Soldermask

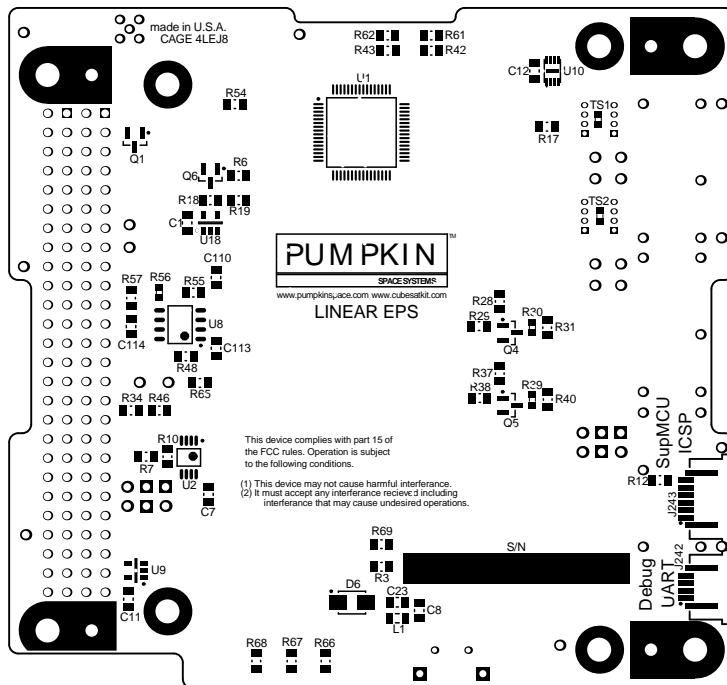


Bottom Silkscreen

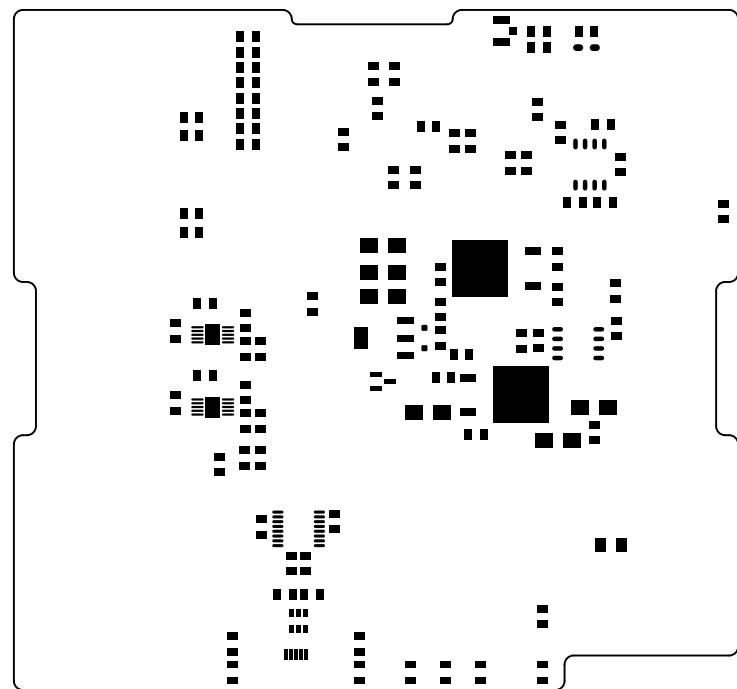
Bottom Soldermask

702-00337E0

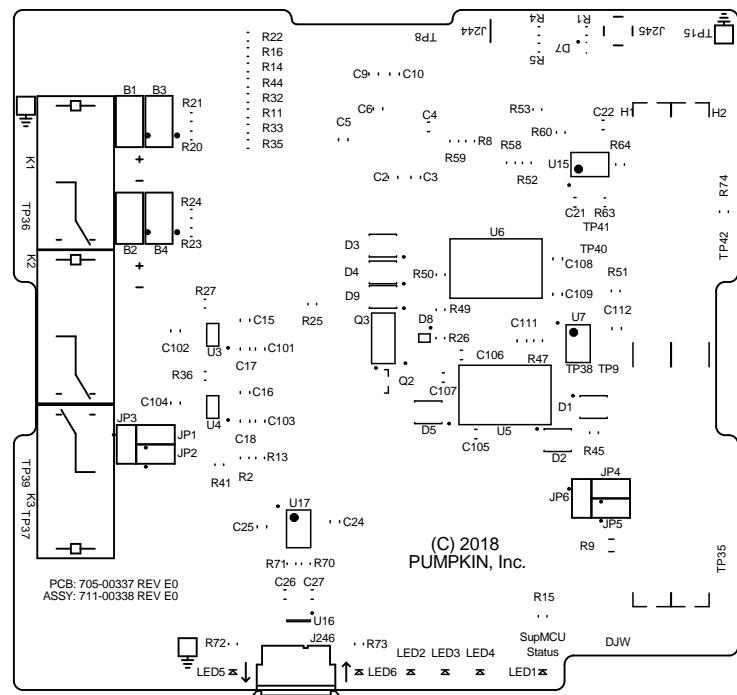
Bottom Soldermask



705-00337E0 Top Sol der Paste

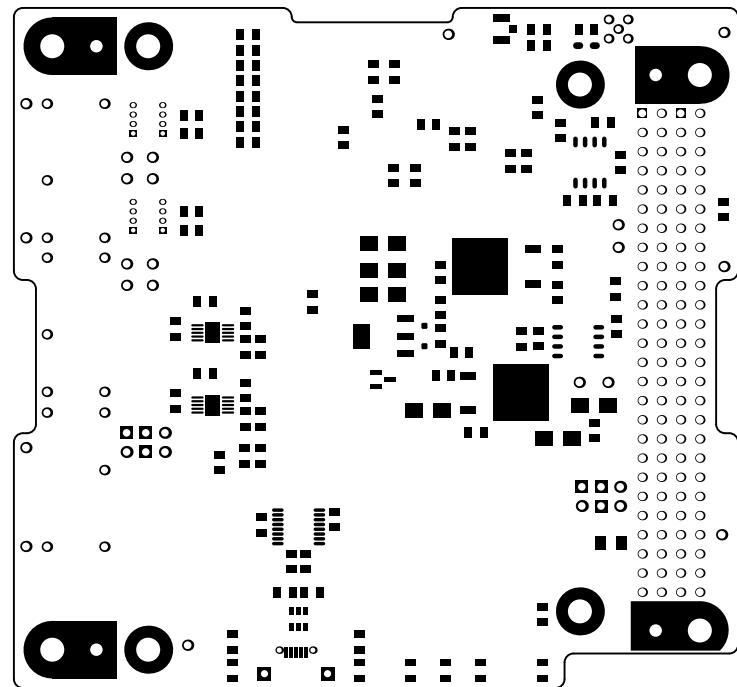


705-00337E0 Top Silkscreen

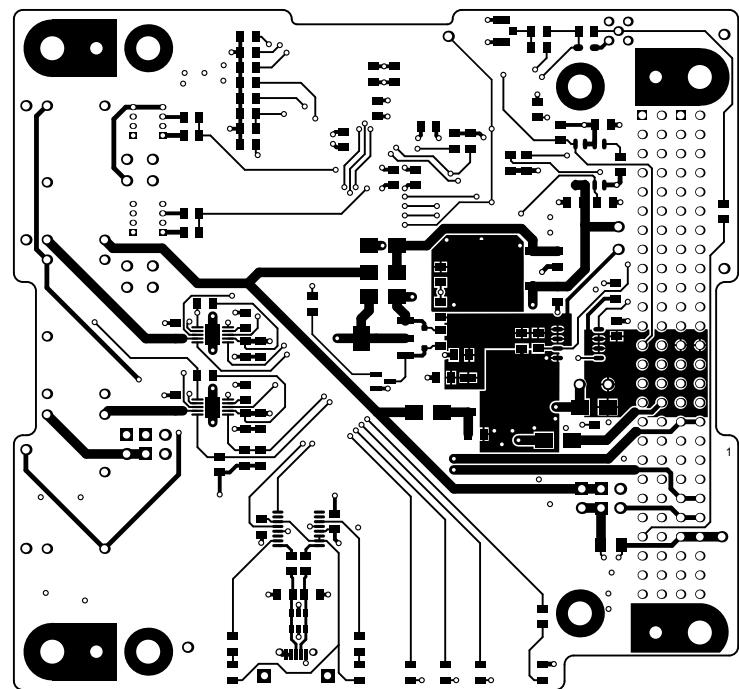


705-00337E0

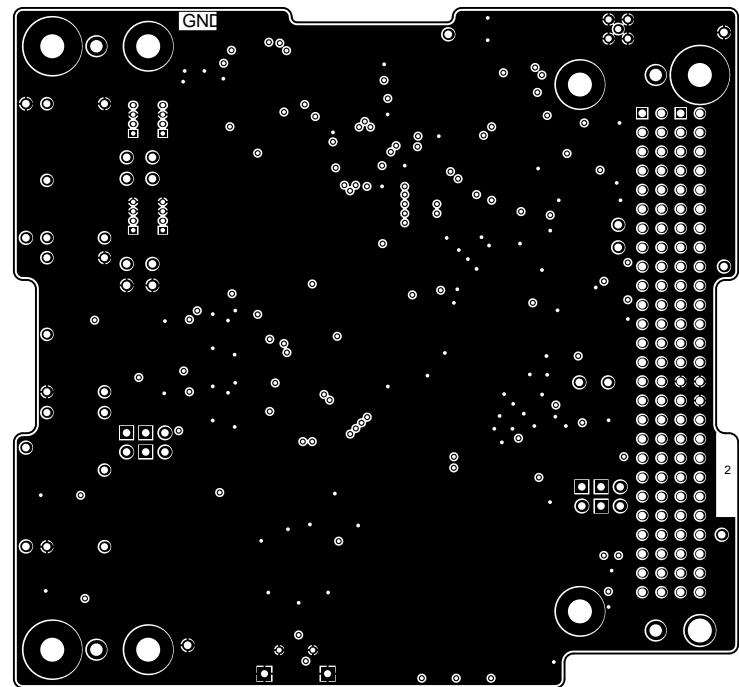
Top Sol dermask



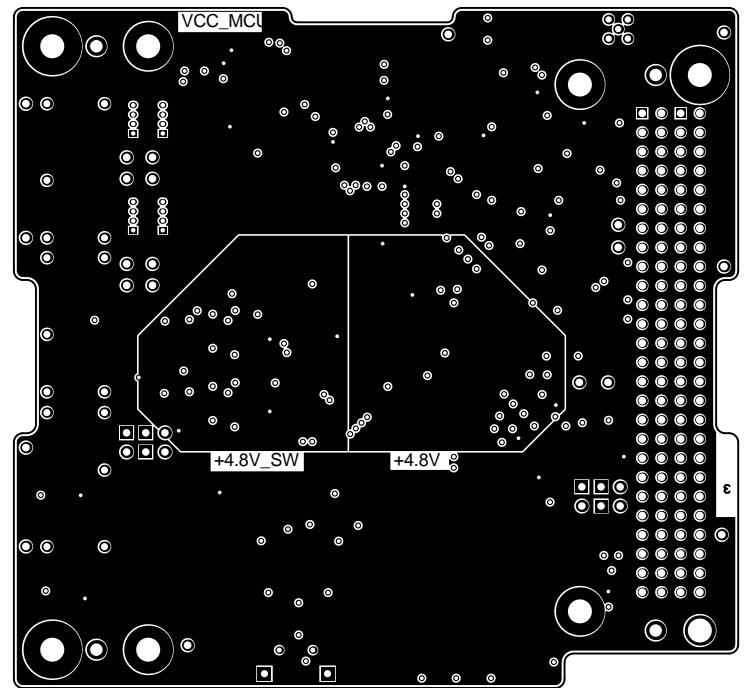
705-00337E0 Layer 1 (TOP)



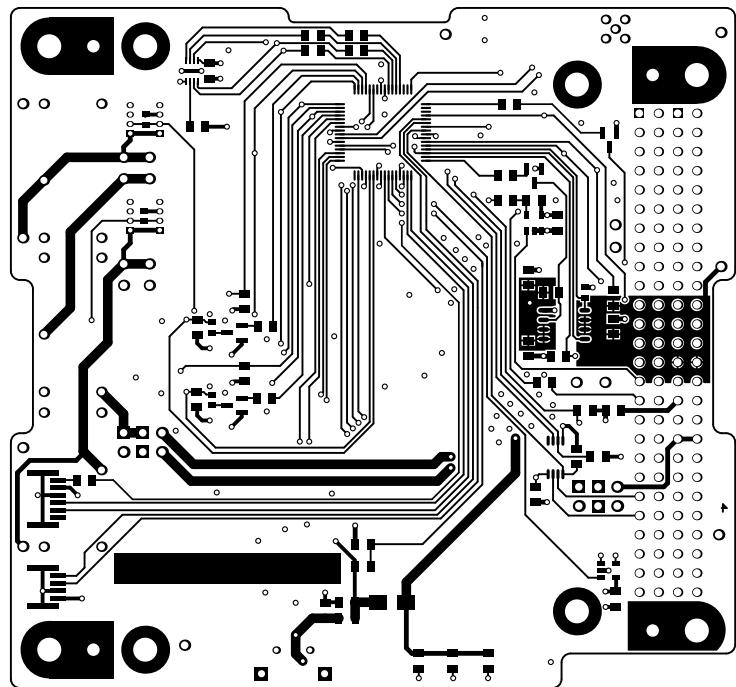
705-00337E0 Layer 2



705-00337E0 Layer 3



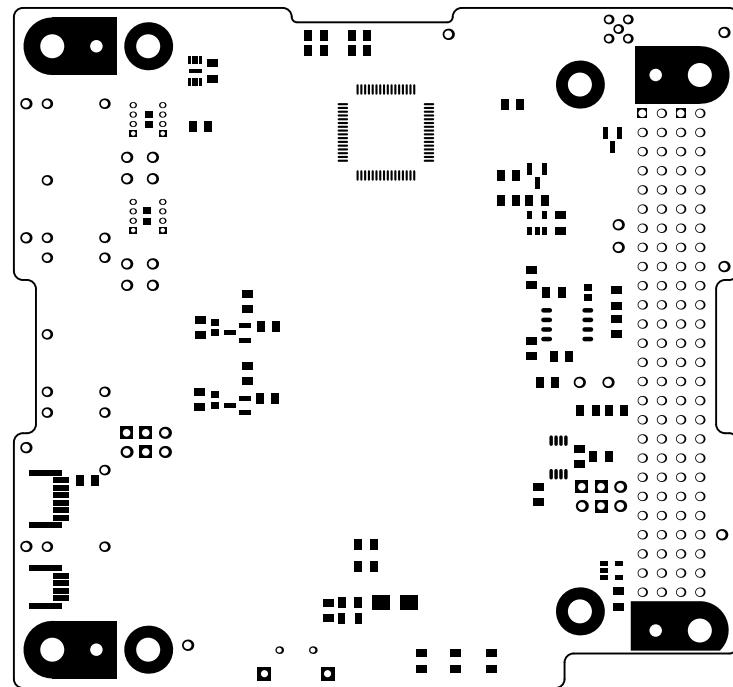
705-00337E0 Layer 4 (BOTTOM)



705-00337E0

Bottom Sol dermask

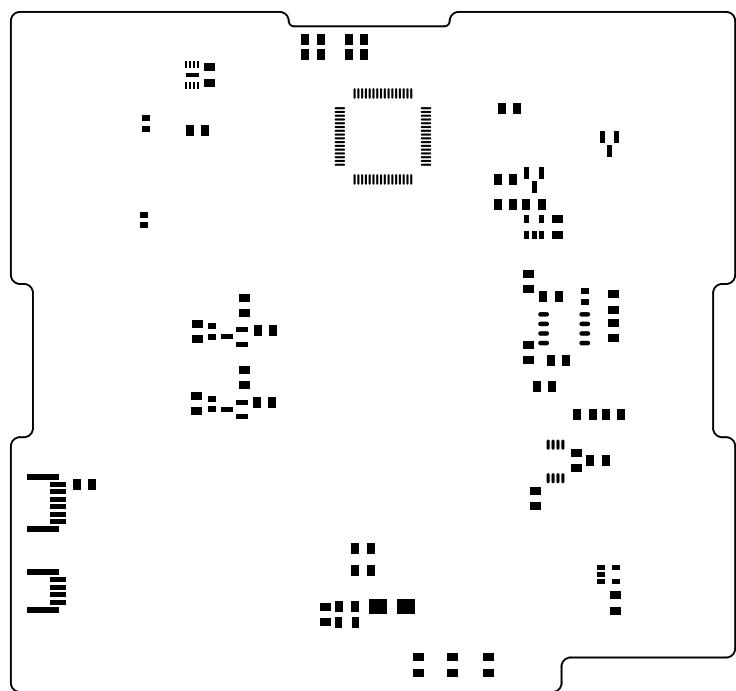
Bottom Sol dermask



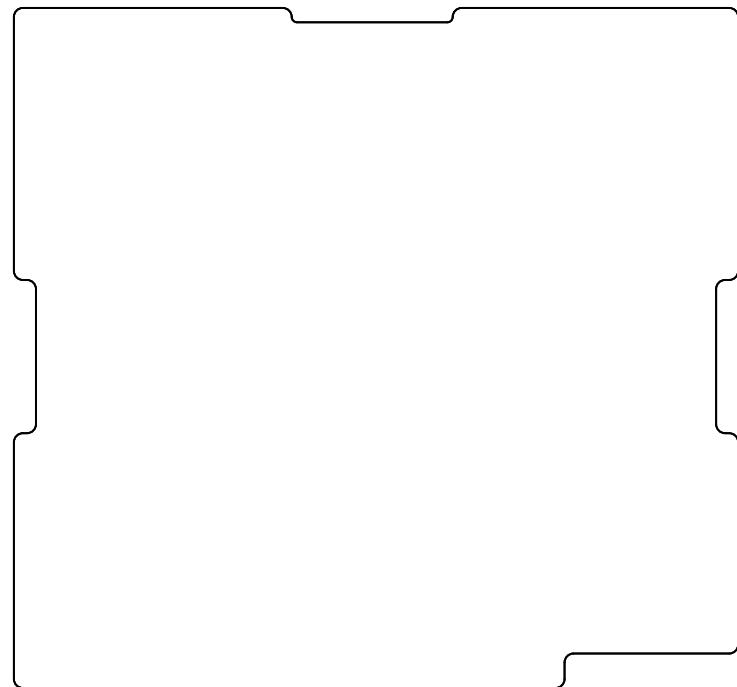
Bottom Sijkscreren

705-00337E0

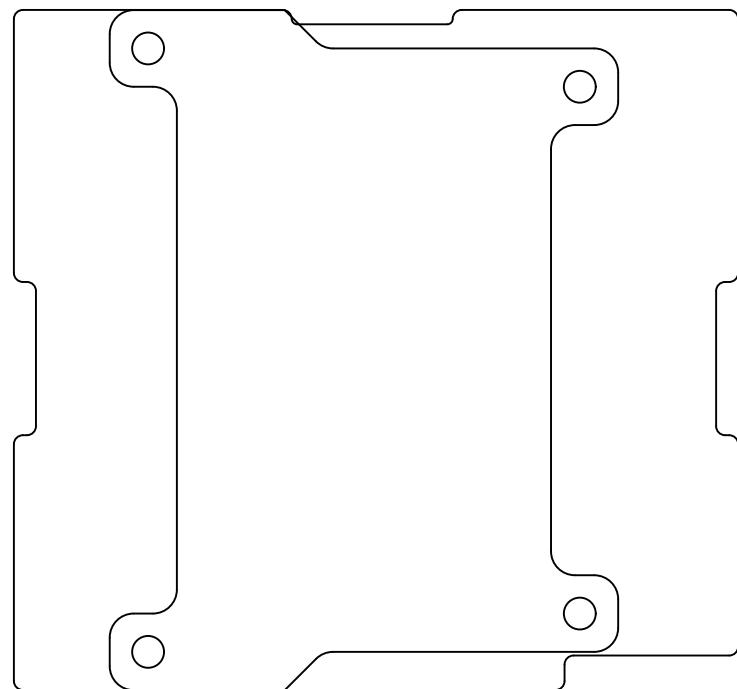
705-00337E0 Bottom Sol der Paste



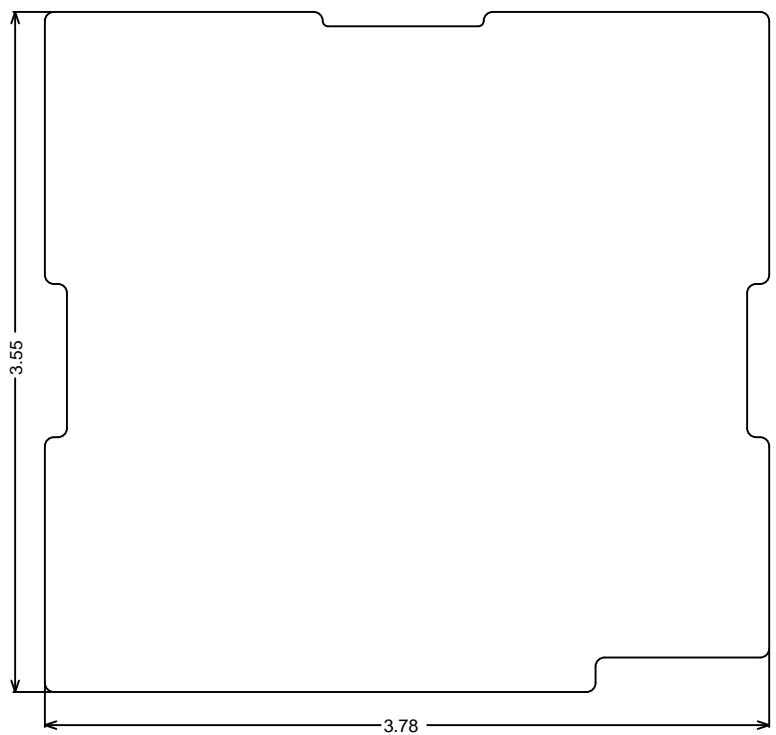
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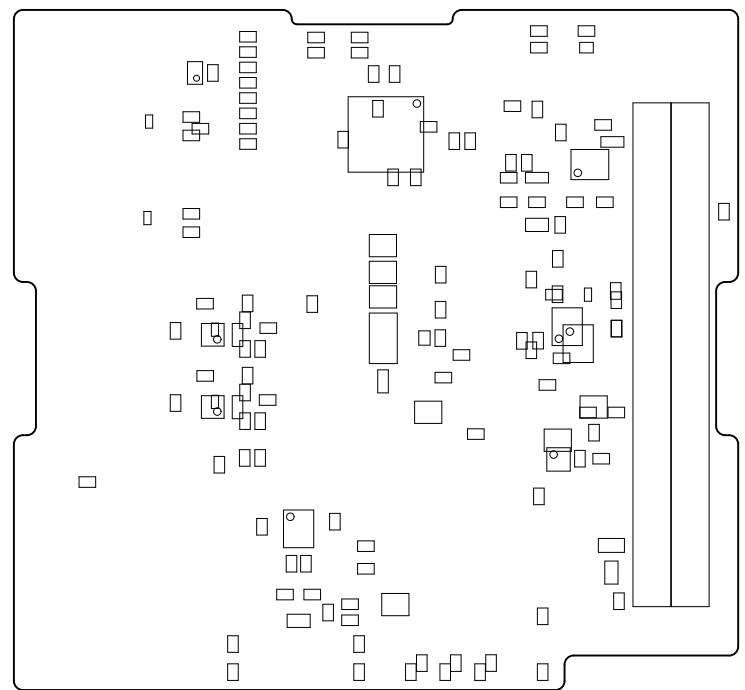
705-00337E0 Mechanical Drawing



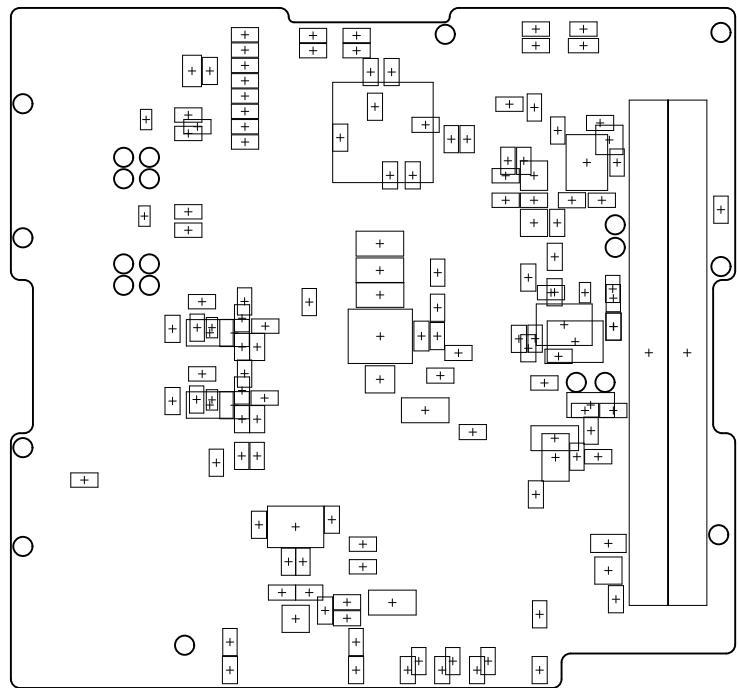
FABRICATION NOTES:

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705-00337E0



705-00337E0



705-00337E0

Drill Drawing



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×	12	39.37mil (1.000mm)	PTH	Round
★	16	23.62mil (0.600mm)	PTH	Round
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P	125	40.16mil (1.020mm)	PTH	Round
⊕	175	19.69mil (0.500mm)	PTH	Round
364 Total				

705-00337E0

